

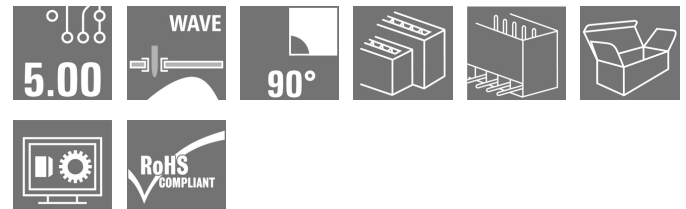
SLD 5.00/22/90G 3.2 SN OR BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

Similar to illustration

2-tier male header with parallel pin arrangement. The solder pin length is optimised for wave flow soldering. The pin headers provide space for labelling and can be coded.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT solder connection, 5.00 mm, Number of poles: 22, 90°, Solder pin length (l): 3.2 mm, tinned, orange, Box
Order No.	1614440000
Type	SLD 5.00/22/90G 3.2 SN OR BX
GTIN (EAN)	4008190030629
Qty.	10 pc(s).
Product data	IEC: 400 V / 11 A UL: 300 V / 10 A
Packaging	Box

Creation date March 24, 2021 11:23:42 AM CET

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Technical data

Dimensions and weights

Depth	22 mm	Depth (inches)	0.866 inch
Height	31.25 mm	Height (inches)	1.23 inch
Height of lowest version	28.05 mm	Net weight	23.45 g
Width	56.96 mm	Width (inches)	2.243 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	90°
Number of poles	22	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	+0.1 / -0.2 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0.03 mm
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D)	+ 0.1 mm
L1 in mm	50 mm	L1 in inches	1.969 inch
Number of rows	2	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	Safe from back-of-hand touch	Volume resistance	≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	3 N
Pulling force/pole, max.	3 N		

Material data

Insulating material	PBT	Colour	orange
Colour chart (similar)	RAL 2000	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 200	UL 94 flammability rating	V-0
Contact material	CuSn	Contact surface	tinned
Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	11 A
Rated current, max. number of poles (Tu=20°C)	8.5 A	Rated current, min. number of poles (Tu=40°C)	9.5 A
Rated current, max. number of poles (Tu=40°C)	7 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Short-time withstand current resistance	1 x 1s with 120 A

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Technical data

Rated data acc. to CSA

Institute (CSA)



Certificate No. (CSA)

200039-1121690

Rated voltage (Use group B / CSA) 300 V

Rated voltage (Use group D / CSA) 300 V

Rated current (Use group B / CSA) 10 A

Rated current (Use group D / CSA) 10 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Rated data acc. to UL 1059

Institute (UR)



Certificate No. (UR)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group B / UL 1059) 10 A

Rated current (Use group D / UL 1059) 10 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Packing

Packaging Box

VPE length 1 mm

VPE width 1 mm

VPE height 1 mm

Classifications

ETIM 6.0 EC002637

ETIM 7.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 9.1 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 11.0 27-46-02-01

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Additional colours on request
- Rated current related to rated cross-section & min. No. of poles.
- Spacing between rows: see hole layout
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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Technical data

Approvals

Approvals



ROHS	Conform
UL File Number Search	E60693

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	STEP
Engineering Data	WSCAD

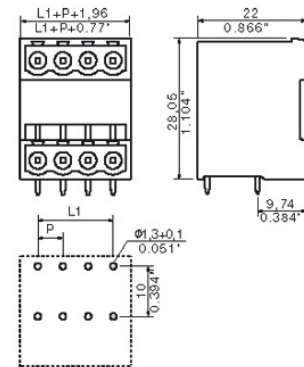
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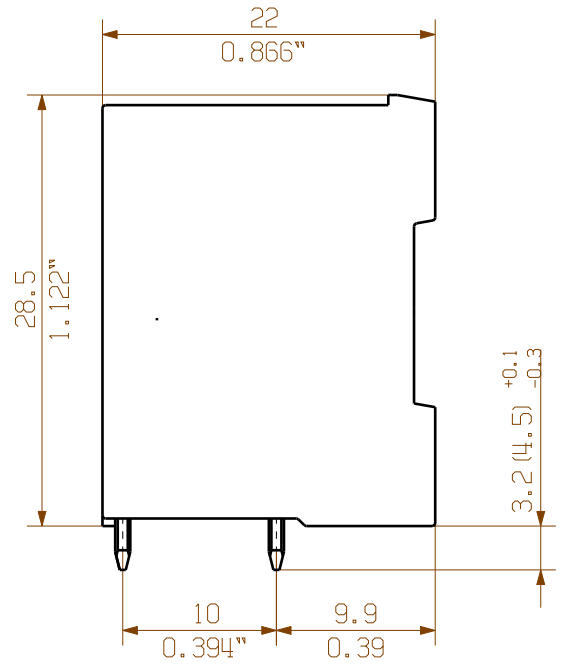
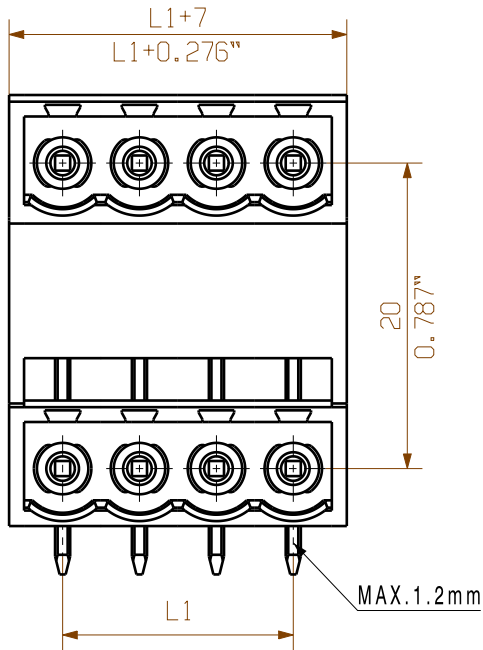
Drawings

Dimensional drawing

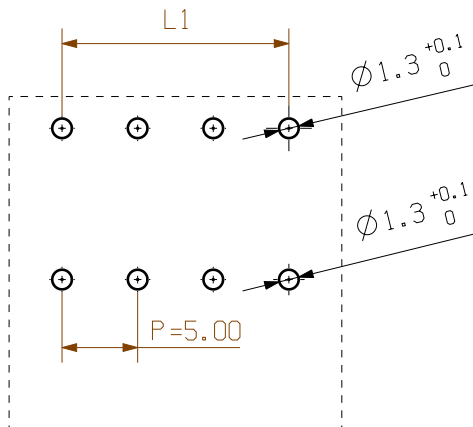


MASSE OHNE TOLERANZ SIND KEINE PRUEFFMASSE
DIMS. WITHOUT TOLERANCE ARE NOT CONTROL DIMS.

DIE DEUTSCHE VERSION IST VERBINDLICH
THE GERMAN VERSION IS BINDING



HOLE PATTERN



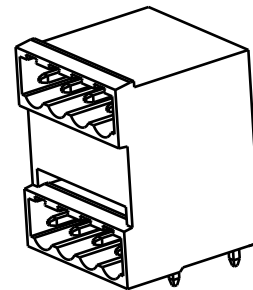
For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.

The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

M 1/1



48	115,00	4,531
46	110,00	4,334
44	105,00	4,137
42	100,00	3,940
40	95,00	3,743
38	90,00	3,546
36	85,00	3,349
34	80,00	3,152
32	75,00	2,955
30	70,00	2,758
28	65,00	2,561
26	60,00	2,364
24	55,00	2,167
22	50,00	1,970
20	45,00	1,773
18	40,00	1,576
16	35,00	1,379
14	30,00	1,182
12	25,00	0,985
10	20,00	0,788
8	15,00	0,591
6	10,00	0,394
4	5,00	0,197
n	L1 [mm]	L1 [Inch]

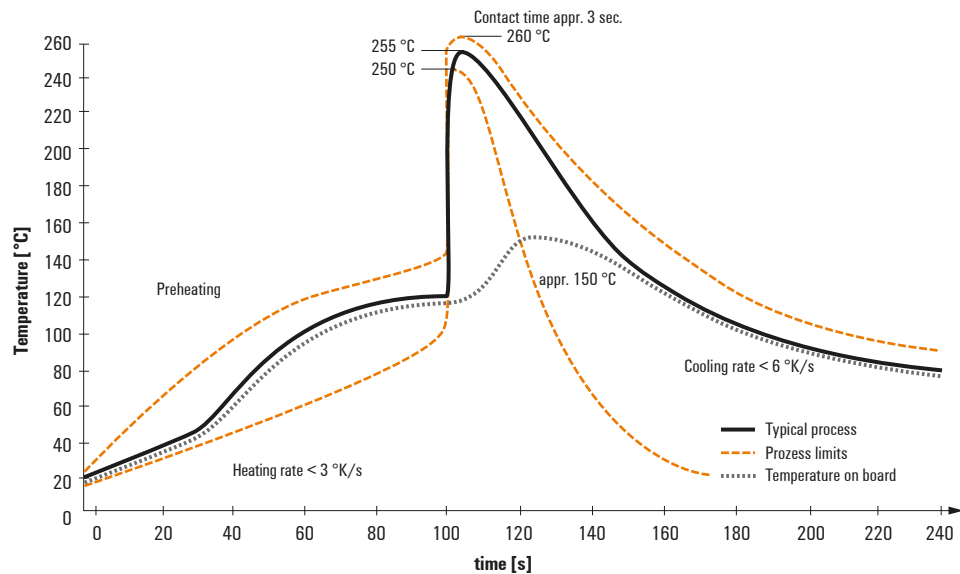
SHOWN:SLD 5.00/08/90G

	METRIC TOLERANCES: X. = ± 0.3 X.X = ± 0.1 X.XX = ± 0.05	51665/0 05.10.10 HERTEL_S 01	CAT.NO.: . . .	
	MODIFICATION		C 19817 09	
	DATE	NAME	DRAWING NO. SHEET 01 OF 01 SHEETS	
	DRAWN	15.12.2009	HELIS_MA	ISSUE NO.
RESPONSIBLE		HERTEL_S	SLD 5.00/.. /90G....	
CHECKED	08.10.2010	HECKERT_M	STIFTELEISTE PIN HEADER	
APPROVED		HECKERT_M	PRODUCT FILE:SLD 5.00 7303	
SCALE: 2/1				
SUPERSEDES: .				

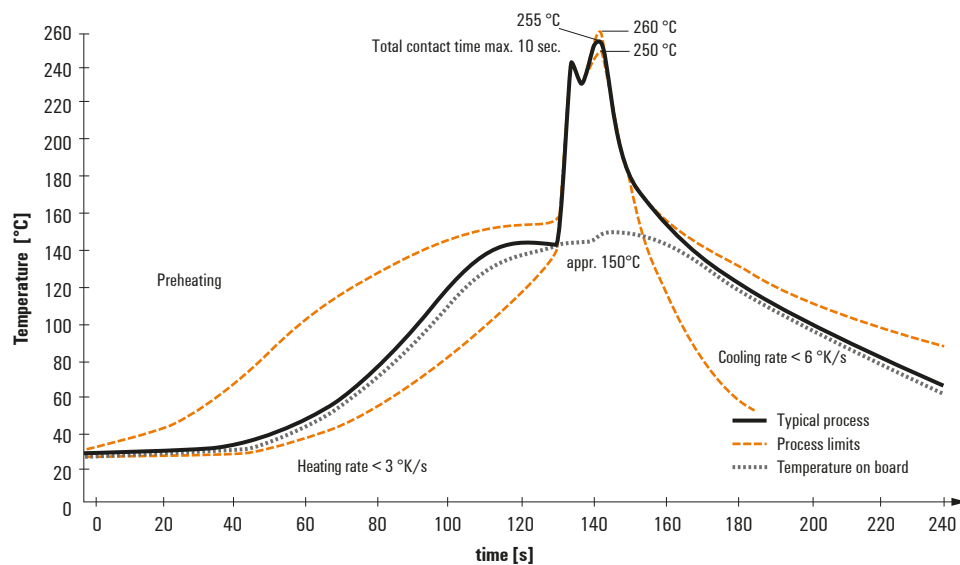
Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.